

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)
Yoshihisa SATOH) Group Art Unit: Unassigned
Application No.: Unassigned) Examiner: Unassigned
Filing Date: December 29, 2000)
For: SYNTHETIC RESIN MOLDING)
MOLD, APPARATUS FOR AND)
METHOD OF ADJUSTING A)
TEMPERATURE OF THE MOLD)

PRELIMINARY AMENDMENT

BOX PCT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to examination, please amend the above-captioned application as follows:

IN THE CLAIMS:

Kindly amend claims 16-18 and 21 as follows:

In claim 16, line 2, delete "1 or".

In claim 17, line 3, delete "1 or".

In claim 18, line 2, delete "1 or".

In claim 21, line 2, delete "1 or".

Kindly add new claims 27-37 as follows:

-- 27. A product molded by the synthetic resin molding mold according to claim 1.

A \\ 28. A method of molding a synthetic resin comprising the steps of:
injecting a thermoplastic resin into the mold according to claim 1;